

# IS456

## High Speed Response Type OPIC Light Detector

### ■ Features

1. High speed response ( $t_{PHL}$  : TYP.230ns)
2. Uses a pattern to allow for possible positional deviation of the semiconductor laser spot.
3. Compact, mini-flat package

### ■ Applications

1. Laser beam printers

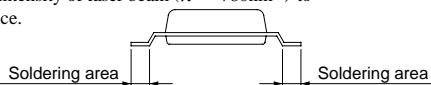
### ■ Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Rating	Unit
*1 Supply voltage	V <sub>CC</sub>	-0.5 to +7	V
High level output voltage	V <sub>OH</sub>	7	V
Low level output current	I <sub>OL</sub>	20	mA
Operating temperature	T <sub>opr</sub>	-25 to +80	°C
Storage temperature	T <sub>stg</sub>	-40 to +85	°C
*2 Soldering temperature	T <sub>sol</sub>	260	°C
Power dissipation	P	150	mW
R <sub>o</sub> terminal power dissipation	P <sub>RO</sub>	24	mW
*3 Incident light intensity	P <sub>I</sub>	5	mW
*3 Radiant intensity	E <sub>e</sub>	60	WB

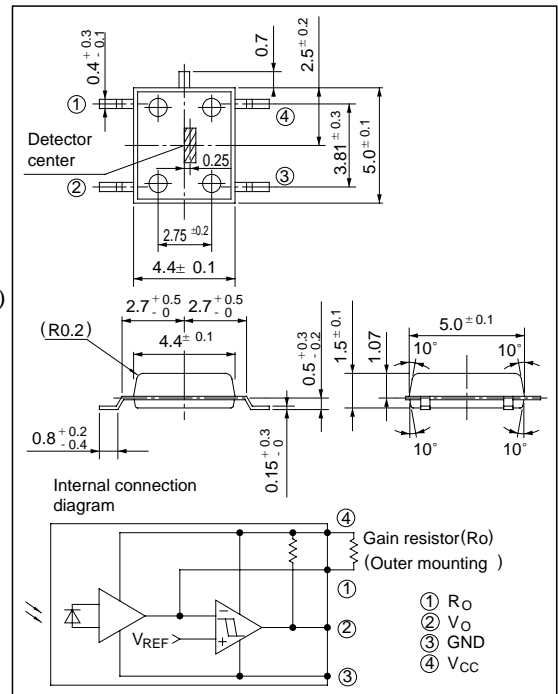
\*1 For 1 minute

\*2 For 3 seconds at the position shown in the following drawing.

\*3 Maximum allowable incident light intensity and radiant intensity of laser beam ( $\lambda = 780\text{nm}$ ) to the device.

### ■ Outline Dimensions

(Unit : mm)



\*4 "OPIC" (Optical IC) is a trademark of the SHARP Corporation.  
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

### ■ Electro-optical Characteristics

(V<sub>CC</sub> = 5V, Ta= 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
High level output voltage	V <sub>OH</sub>	R <sub>o</sub> =51kΩ, E <sub>v</sub> =0	4.9	-	-	V
Low level output voltage	V <sub>OL</sub>	I <sub>OL</sub> =10mA, E <sub>v</sub> =1 000lx	-	0.4	0.6	V
High level supply current	I <sub>CCH</sub>	R <sub>o</sub> =51kΩ, E <sub>v</sub> =0	-	2.6	4.5	mA
Low level supply current	I <sub>CCL</sub>	R <sub>o</sub> =51kΩ, E <sub>v</sub> =1 000lx	-	3.8	6.6	mA
*4 "High→Low" threshold illuminance 1	E <sub>VHL1</sub>	R <sub>o</sub> =51kΩ	330	470	600	lx
*4 "High→Low" threshold illuminance 2	E <sub>VHL2</sub>	R <sub>o</sub> =5.1kΩ	-	5 800	-	lx
"High→Low" threshold incident light intensity	P <sub>IHL</sub>	R <sub>o</sub> =5.1kΩ, l = 780nm	-	100	-	μW
Response time	"High→Low" propagation delay time	t <sub>PHL</sub>	-	230	400	ns
	"Low→High" propagation delay time	t <sub>PLH</sub>	-	230	400	ns
	Rise time	t <sub>r</sub>	-	60	200	ns
	Fall time	t <sub>f</sub>	-	20	100	ns

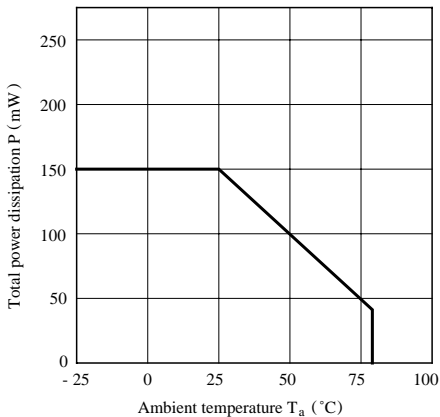
\*4 E<sub>VHL1</sub>, E<sub>VHL2</sub> represent illuminance by CIE standard light source A (tungsten lamp) when output goes from high to low.

**■ Recommended Operating Conditions**

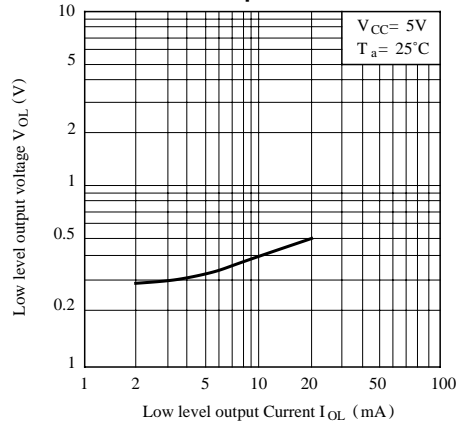
Parameter	Symbol	MIN.	MAX.	Unit
Operating supply voltage	$V_{cc}$	4.5	5.5	V
Operating temperature	$T_{opr}$	0	60	°C
Incident light intensity ( $\lambda = 780nm$ )	$P_I$	-	2.5	mW

In order to stabilize power supply line, connect a by-pass capacitor of 0.1 $\mu$ F between Vcc and GND near the device.

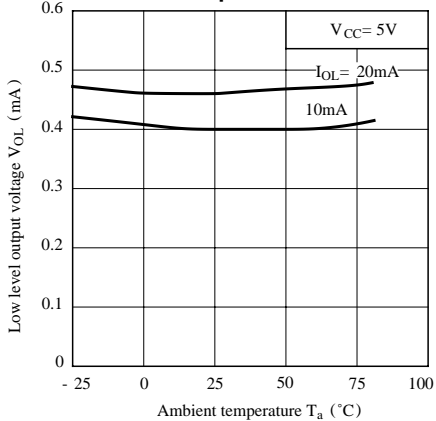
**Fig. 1 Total Power Dissipation vs. Ambient Temperature**



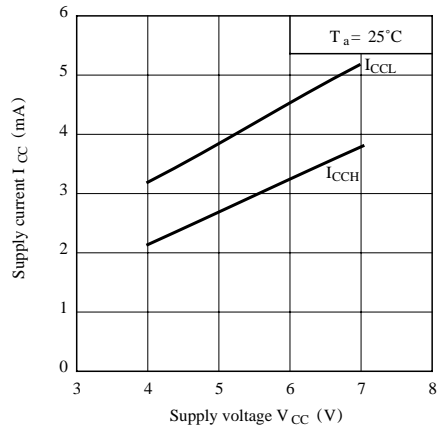
**Fig. 2 Low Level Output Voltage vs. Low Level Output Current**



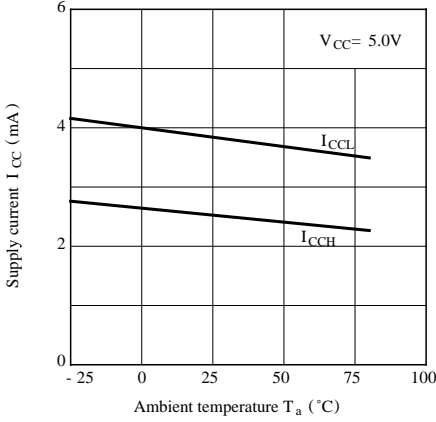
**Fig. 3 Low Level Output Voltage vs. Ambient Temperature**



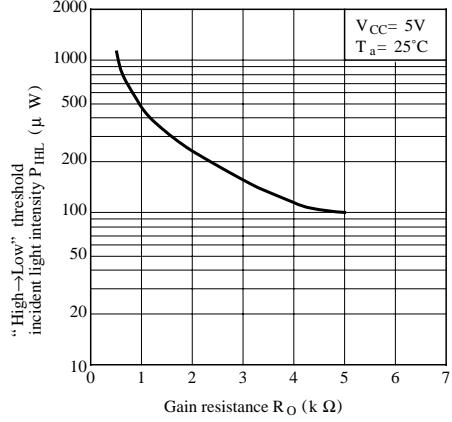
**Fig. 4 Supply Current vs. Supply Voltage**



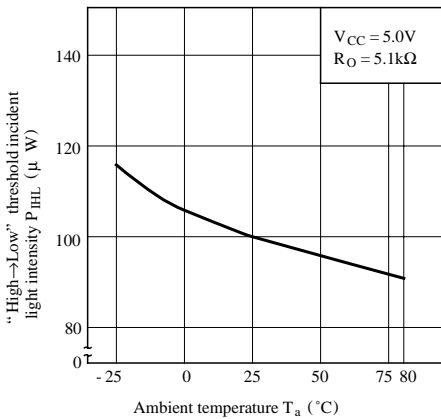
**Fig. 5 Supply Current vs. Ambient Temperature**



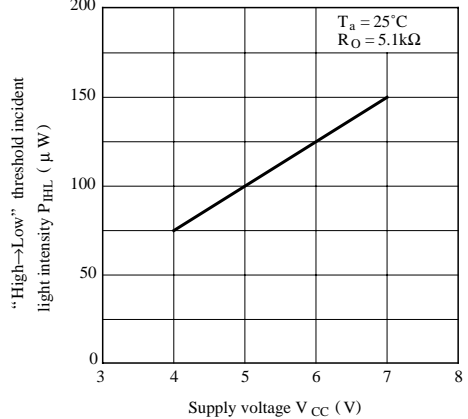
**Fig. 6 “High →Low” Threshold Incident Light Intensity vs. Gain Resistance**



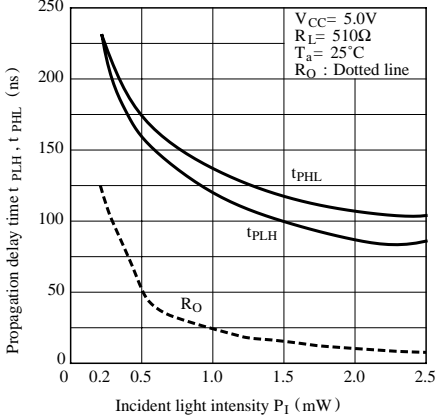
**Fig. 7 “High →Low” Threshold Incident Light Intensity vs. Ambient Temperature**



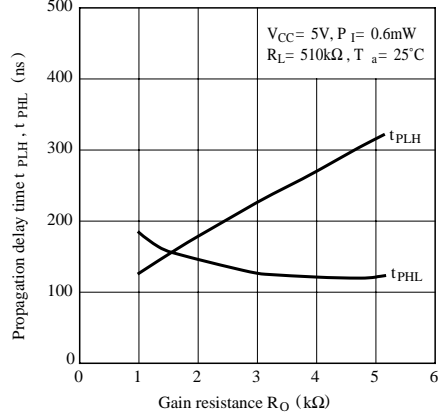
**Fig. 8 “High →Low” Threshold Incident Light Intensity vs. Supply Voltage**



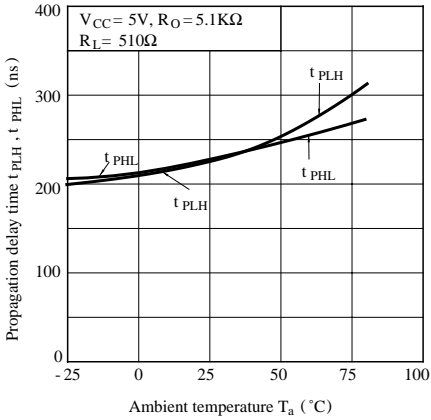
**Fig. 9 Propagation Delay Time vs. Incident Light Intensity**



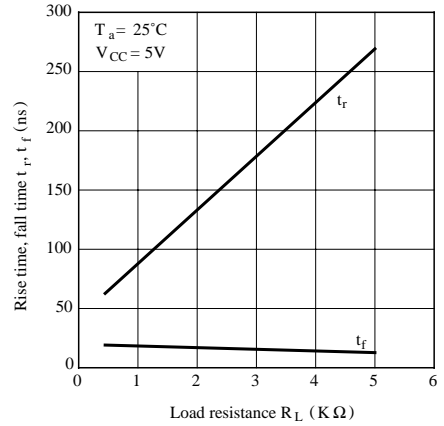
**Fig.10 Propagation Delay Time vs. Gain Resistance**



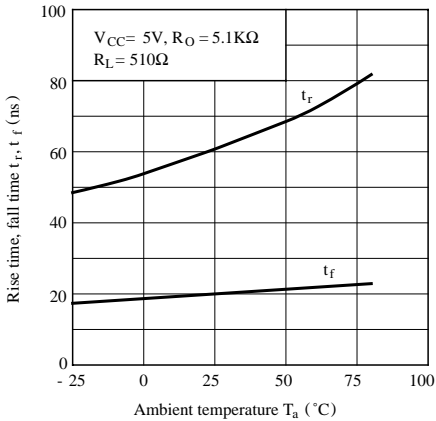
**Fig.11 Propagation Delay Time vs. Ambient Temperature**



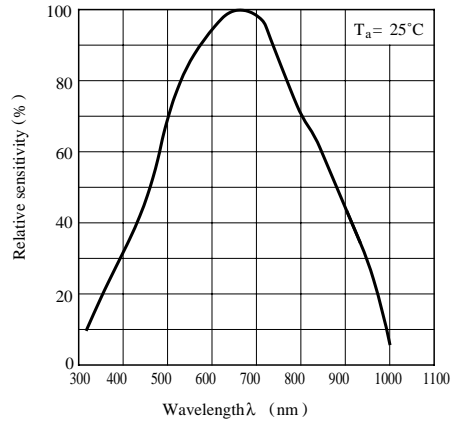
**Fig.12 Rise Time, Fall Time vs. Load Resistance**



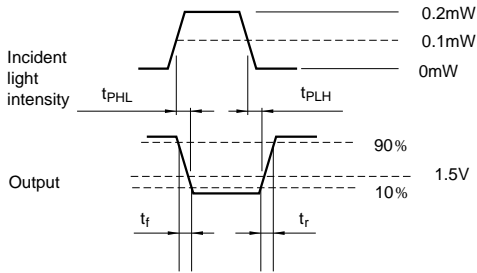
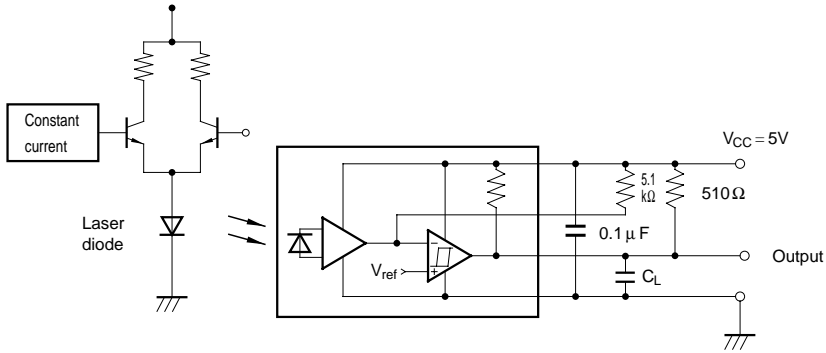
**Fig.13 Rise Time, Fall Time vs. Ambient Temperature**



**Fig.14 Spectral Sensitivity**



Test Circuit for Response Time



● Please refer to the chapter “Precautions for Use.”

### NOTICE

- The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
  - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
    - Personal computers
    - Office automation equipment
    - Telecommunication equipment [terminal]
    - Test and measurement equipment
    - Industrial control
    - Audio visual equipment
    - Consumer electronics
  - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
    - Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
    - Traffic signals
    - Gas leakage sensor breakers
    - Alarm equipment
    - Various safety devices, etc.
  - (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
    - Space applications
    - Telecommunication equipment [trunk lines]
    - Nuclear power control equipment
    - Medical and other life support equipment (e.g., scuba).
- Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
- If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Control Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.